Panasonic

LNA2403F, LNA2402L (LN151F, LN151L) GaAs Infrared Light Emitting Diodes

For optical control systems

Features

- High-power output, high-efficiency : $P_0 = 7.5 \text{ mW}$ (typ.)
- Fast response and high-speed modulation capability :

 $t_{\rm r}, t_{\rm f} = 1 \ \mu s \ (typ.)$

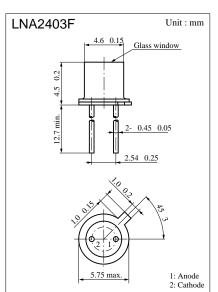
- Infrared light emission close to monochromatic light : $\lambda_P = 950 \text{ nm} (typ.)$
- Narrow directivity, suitable for effective use of radiant power (LNA2402L (LN151L))
- Wide directivity, matched for external optical systems (LNA2403F (LN151F))

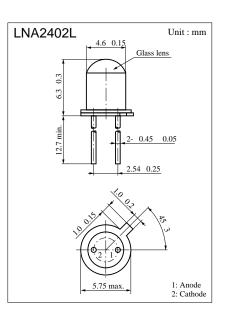
Absolute Maximum Ratings ($Ta = 25^{\circ}C$)

• TO-18 standard type package

Parameter Symbol Ratings Unit Power dissipation P_D 160 mW Forward current (DC) 100 I_F mA Pulse forward current 2 I_{FP}* Α Reverse voltage (DC) V V_R 3 -25 to +100°C Operating ambient temperature Topr -30 to+100 °C Storage temperature T_{stg}

* f = 100 Hz, Duty cycle = 0.1 %



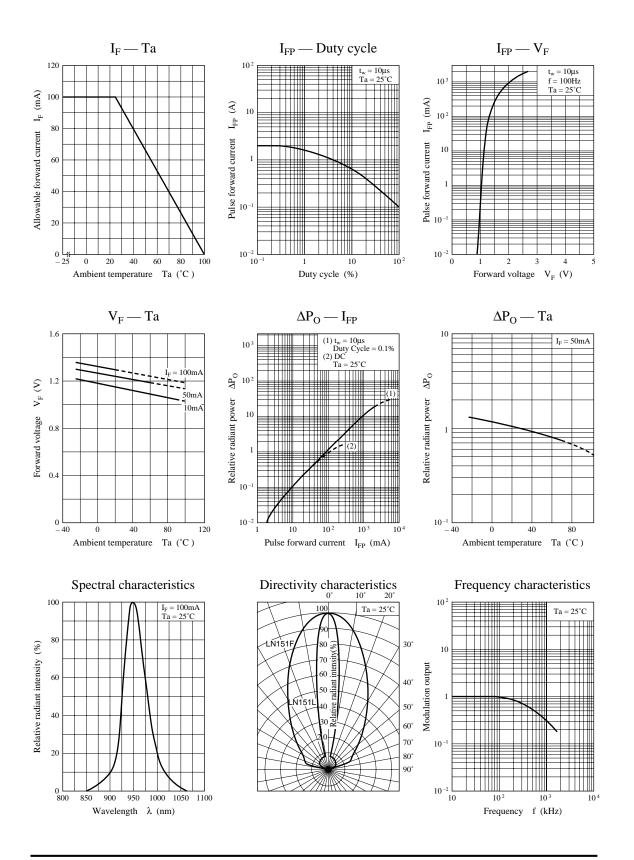


Electro-Optical Characteristics ($Ta = 25^{\circ}C$)

Parameter		Symbol	Conditions	min	typ	max	Unit
Radiant power		Po	$I_F = 100 \text{mA}$	5	7.5		mW
Peak emission wavelength		$\lambda_{\rm P}$	$I_F = 100 \text{mA}$		950		nm
Spectral half band width		Δλ	$I_F = 100 \text{mA}$		50		nm
Forward voltage (DC)		V _F	$I_F = 100 \text{mA}$		1.3	1.6	V
Reverse current (DC)		I _R	$V_R = 3V$			10	μΑ
Capacitance between pins		Ct	$V_R = 0V$, $f = 1MHz$		60		pF
Rise time		t _r	I _{FP} = 100mA		1		μs
Fall time		t _f			1		μs
Half-power angle	LNA2403F	θ	The angle in which radiant intencity is 50%		32		deg.
	LNA2402L				8		deg.

Note) The part numbers in the parenthesis show conventional part number.





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▲ Caution for Safety



Gallium arsenide material (GaAs) is used in this product.

Therefore, do not burn, destroy, cut, crush, or chemically decompose the product, since gallium arsenide material in powder or vapor form is harmful to human health.

Observe the relevant laws and regulations when disposing of the products. Do not mix them with ordinary industrial waste or household refuse when disposing of GaAs-containing products.

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